Smart Highside High Current Power Switch

Reversave™
- Reverse battery protection by self turn on of power MOSFET

Features
- Overload protection
- Current limitation
- Short circuit protection
- Overtemperature protection
- Overvoltage protection (including load dump)
- Clamp of negative voltage at output
- Fast deenergizing of inductive loads [1]
- Low ohmic inverse current operation
- Diagnostic feedback with load current sense
- Open load detection via current sense
- Loss of V_{bb} protection[2]
- **E**lectro**s**tatic **d**ischarge (**ESD**) protection
- Green Product (RoHS compliant)
- AEC qualified

Product Summary

|			
Overvoltage protection	$V_{bb(AZ)}$	62	V
Output clamp	$V_{ON(CL)}$	44	V
Operating voltage	$V_{bb(on)}$	5.0 ... 34	V
On-state resistance	R_{ON}	2.5	mΩ
Load current (ISO)	$I_{L(ISO)}$	165	A
Short circuit current limitation	$I_{L(SCp)}$	520	A
Current sense ratio	$I_L : I_{IS}$	30 000	

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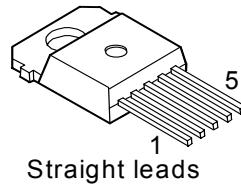
Straight leads

Application
- Power switch with current sense diagnostic feedback for 12 V and 24 V DC grounded loads
- Most suitable for loads with high inrush current like lamps and motors; all types of resistive and inductive loads
- Replaces electromechanical relays, fuses and discrete circuits

General Description
N channel vertical power FET with charge pump, current controlled input and diagnostic feedback with load current sense, integrated in Smart SIPMOS® chip on chip technology. Providing embedded protective functions.

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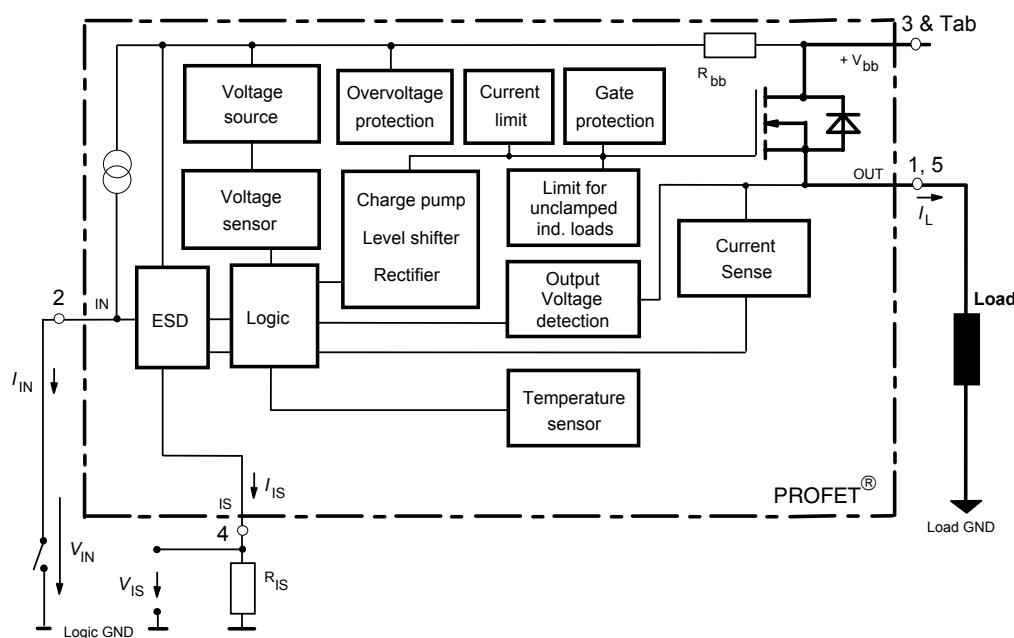
[1] With additional external diode.

[2] Additional external diode required for energized inductive loads (see page 9).

Pin	Symbol	Function
1	OUT	Output to the load. The pins 1 and 5 must be shorted with each other especially in high current applications![3]
2	IN	Input, activates the power switch in case of short to ground
3	Vbb	Positive power supply voltage, the tab is electrically connected to this pin. In high current applications the tab should be used for the V_{bb} connection instead of this pin[4].
4	IS	Diagnostic feedback providing a sense current proportional to the load current; zero current on failure (see Truth Table on page 7)
5	OUT	Output to the load. The pins 1 and 5 must be shorted with each other especially in high current applications![3]

Maximum Ratings at T_j = 25 °C unless otherwise specified

Parameter	Symbol	Values	Unit
Supply voltage (see page 4 and 5)	V_{bb}	40	V
Supply voltage for full short circuit protection, (E_{AS} limitation see diagram on page 10) $T_{j,start}$=-40°C…+150°C:	V_{bb}	34	V
Load current (short circuit current, see page 5)	I_L	self-limited	A
Load dump protection $V_{LoadDump} = U_A + V_s$, $U_A = 13.5\,V$ $R_I{}^{5)} = 2\,\Omega$, $R_L = 0.1\,\Omega$, $t_d = 200\,ms$, IN, IS = open or grounded	$V_{Load\,dump}{}^{6)}$	80	V
Operating temperature range	T_j	-40 ...+150	°C
Storage temperature range	T_{stg}	-55 ...+150	
Power dissipation (DC), $T_C \le 25$ °C	P_{tot}	360	W
Inductive load switch-off energy dissipation, single pulse $V_{bb} = 12V$, $T_{j,start} = 150°C$, $T_C = 150°C$ const., $I_L = 20\,A$, $Z_L = 15\,mH$, $0\,\Omega$, see diagram on page 10	E_{AS}	3	J
Electrostatic discharge capability (ESD) Human Body Model acc. MIL-STD883D, method 3015.7 and ESD assn. std. S5.1-1993, C = 100 pF, R = 1.5 kΩ	V_{ESD}	4.0	kV
Current through input pin (DC)	I_{IN}	+15 , -250	mA
Current through current sense status pin (DC) see internal circuit diagrams on page 8 and 9	I_{IS}	+15 , -250	

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[3] Not shorting all outputs will considerably increase the on-state resistance, reduce the peak current capability and decrease the current sense accuracy

[4] Otherwise add up to 0.5 mΩ (depending on used length of the pin) to the R_{ON} if the pin is used instead of the tab.

[5] R_I = internal resistance of the load dump test pulse generator.

[6] $V_{Load\,dump}$ is setup without the DUT connected to the generator per ISO 7637-1 and DIN 40839.

Thermal Characteristics

Parameter and Conditions	Symbol	Values			Unit
		min	typ	max	
Thermal resistance chip - case:	R_{thJC}[7]	--	--	0.35	K/W
junction - ambient (free air):	R_{thJA}	--	30	--	

Electrical Characteristics

Parameter and Conditions	Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified		min	typ	max	

Load Switching Capabilities and Characteristics

Parameter and Conditions	Symbol	Values			Unit
On-state resistance (Tab to pins 1,5, see measurement circuit page 7) I_L = 30 A, T_j = 25 °C:	R_{ON}	--	1.9	2.5	mΩ
V_{IN} = 0, I_L = 30 A, T_j = 150 °C:		--	3.3	4.0	
I_L = 120 A, T_j = 150 °C:		--	--	4.0	
V_{bb} = 6 V[8], I_L = 20 A, T_j = 150 °C:	$R_{ON(Static)}$	--	4.6	9.0	
Nominal load current[9] (Tab to pins 1,5) ISO 10483-1/6.7: V_{ON} = 0.5 V, T_C = 85 °C [10]	$I_{L(ISO)}$	128	165	--	A
Maximum load current in resistive range (Tab to pins 1,5) V_{ON} = 1.8 V, T_C = 25 °C:	$I_{L(Max)}$	520	--	--	
see diagram on page 13 V_{ON} = 1.8 V, T_C = 150 °C:		360	--	--	A
Turn-on time[11] I_{IN} ⊓ to 90% V_{OUT}:	t_{on}	120	--	600	µs
Turn-off time I_{IN} ⊔ to 10% V_{OUT}:	t_{off}	50	--	200	
R_L = 1 Ω , T_j = -40...+150°C					
Slew rate on [11] (10 to 30% V_{OUT}) R_L = 1 Ω	dV/dt$_{on}$	0.3	0.5	0.8	V/µs
Slew rate off [11] (70 to 40% V_{OUT}) R_L = 1 Ω	-dV/dt$_{off}$	0.3	0.7	1	V/µs

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[7] Thermal resistance R_{thCH} case to heatsink (about 0.25 K/W with silicone paste) not included!

[8] Decrease of V_{bb} below 10 V causes slowly a dynamic increase of R_{ON} to a higher value of $R_{ON(Static)}$. As long as V_{bIN} > $V_{bIN(u)\ max}$, R_{ON} increase is less than 10 % per second for T_J < 85 °C.

[9] not subject to production test, specified by design

[10] T_J is about 105°C under these conditions.

[11] See timing diagram on page 14.

Parameter and Conditions	Symbol	Values			Unit
at $T_j = $ -40 ... +150 °C, $V_{bb} = 12$ V unless otherwise specified		min	typ	max	
Inverse Load Current Operation					
On-state resistance (Pins 1,5 to pin 3) $V_{bIN} = 12$ V, $I_L = $ - 30 A $T_j = 25$ °C: see description on page 10 $T_j = 150$ °C:	$R_{ON(inv)}$	-- 	1.9 3.3	2.5 4.0	mΩ
Nominal inverse load current (Pins 1,5 to Tab) $V_{ON} = $ -0.5 V, $T_C = 85$ °C[10]	$I_{L(inv)}$	128	165	--	A
Drain-source diode voltage ($V_{out} > V_{bb}$) $I_L = $ - 20 A, $I_{IN} = 0$, $T_j = +150$°C	- V_{ON}	--	0.6	0.7	V
Operating Parameters					
Operating voltage ($V_{IN} = 0$) [12]	$V_{bb(on)}$	5.0	--	34	V
Undervoltage shutdown [13]	$V_{bIN(u)}$	1.5	3.0	4.5	V
Undervoltage start of charge pump see diagram page 15	$V_{bIN(ucp)}$	3.0	4.5	6.0	V
Overvoltage protection[14] $T_j = $ -40°C: $I_{bb} = 15$ mA $T_j = 25...+150$°C:	$V_{bIN(Z)}$	60 62	-- 66	-- --	V
Standby current $T_j = $ -40...+25°C: $I_{IN} = 0$ $T_j = 150$°C:	$I_{bb(off)}$	-- --	15 25	25 50	µA

[12] If the device is turned on before a V_{bb}-decrease, the operating voltage range is extended down to $V_{bIN(u)}$. For all voltages 0 ... 34 V the device provides embedded protection functions against overtemperature and short circuit.

[13] $V_{bIN} = V_{bb} - V_{IN}$ see diagram on page 7. When V_{bIN} increases from less than $V_{bIN(u)}$ up to $V_{bIN(ucp)} = 5$ V (typ.) the charge pump is not active and $V_{OUT} \approx V_{bb} - 3$ V.

[14] See also $V_{ON(CL)}$ in circuit diagram on page 8.

Parameter and Conditions	Symbol	Values			Unit
at $T_j = -40 \dots +150\,°C$, $V_{bb} = 12\,V$ unless otherwise specified		min	typ	max	

Protection Functions[15]

Parameter and Conditions	Symbol	min	typ	max	Unit
Short circuit current limit (Tab to pins 1,5)[16] $V_{ON} = 12\,V$, time until shutdown max. 300 µs $T_c = -40°C$: $\quad T_c = 25°C$: $\quad T_c = +150°C$:	$I_{L(SCp)}$	200 200 300	320 400 480	550 620 650	A
Short circuit shutdown delay after input current positive slope, $V_{ON} > V_{ON(SC)}$ min. value valid only if input "off-signal" time exceeds 30 µs	$t_{d(SC)}$	80	--	300	µs
Output clamp [17] $\quad\quad\quad\quad I_L = 40\,mA$: (inductive load switch off)	$-V_{OUT(CL)}$	14	17	20	V
Output clamp (inductive load switch off) at $V_{OUT} = V_{bb} - V_{ON(CL)}$ (e.g. overvoltage) $I_L = 40\,mA$	$V_{ON(CL)}$	40	44	47	V
Short circuit shutdown detection voltage (pin 3 to pins 1,5)	$V_{ON(SC)}$	--	6	--	V
Thermal overload trip temperature	T_{jt}	150	--	--	°C
Thermal hysteresis	ΔT_{jt}	--	10	--	K

Reverse Battery

Parameter and Conditions	Symbol	min	typ	max	Unit
Reverse battery voltage [18]	$-V_{bb}$	--	--	16	V
On-state resistance (Pins 1,5 to pin 3) $\quad T_j = 25°C$: $V_{bb} = -12V$, $V_{IN} = 0$, $I_L = -30\,A$, $R_{IS} = 1\,k\Omega \quad T_j = 150°C$:	$R_{ON(rev)}$	--	2.3 3.9	3.0 4.7	mΩ
Integrated resistor in V_{bb} line $\quad T_j = 25°C$: $\quad T_j = 150°C$:	R_{bb}	90 105	110 125	135 150	Ω

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[15] Integrated protection functions are designed to prevent IC destruction under fault conditions described in the data sheet. Fault conditions are considered as "outside" normal operating range. Protection functions are not designed for continuous repetitive operation.

[16] Short circuit is a failure mode. The device is not designed to operate continuously into a short circuit by permanent resetting the short circuit latch function. The lifetime will be reduced under such conditions.

[17] This output clamp can be "switched off" by using an additional diode at the IS-Pin (see page 8). If the diode is used, V_{OUT} is clamped to $V_{bb} - V_{ON(CL)}$ at inductive load switch off.

[18] The reverse load current through the intrinsic drain-source diode has to be limited by the connected load (as it is done with all polarity symmetric loads). Note that under off-conditions ($I_{IN} = I_{IS} = 0$) the power transistor is not activated. This results in raised power dissipation due to the higher voltage drop across the intrinsic drain-source diode. The temperature protection is not active during reverse current operation! Increasing reverse battery voltage capability is simply possible as described on page 9.

Parameter and Conditions	Symbol	Values			Unit
at T_j = -40 ... +150 °C, V_{bb} = 12 V unless otherwise specified		min	typ	max	

Diagnostic Characteristics

Parameter and Conditions	Symbol	min	typ	max	Unit
Current sense ratio, static on-condition, $k_{ILIS} = I_L : I_{IS}$, $V_{ON} < 1.5 \text{V}$ [19], $V_{IS} < V_{OUT}$ - 5 v, $V_{bIN} > 4.0 \text{V}$ (see diagram on page 12) $I_L = 120 \text{A}, T_j = -40°C$:	k_{ILIS}	25 000	29 000	34 000	
$T_j = 25°C$:		26 000	28 500	32 000	
$T_j = 150°C$:		24 000	26 500	29 000	
$I_L = 30 \text{A}, T_j = -40°C$:		25 000	31 200	40 000	
$T_j = 25°C$:		25 000	30 200	35 000	
$T_j = 150°C$:		23 000	27 200	31 500	
$I_L = 16 \text{A}, T_j = -40°C$:		24 000	33 500	48 000	
$T_j = 25°C$:		24 000	31 500	40 000	
$T_j = 150°C$:		23 000	27 500	32 000	
$I_L = 12 \text{A}, T_j = -40°C$:		23 000	40 500	61 000	
$T_j = 25°C$:		23 000	40 500	45 000	
$T_j = 150°C$:		23 000	29 000	34 000	
I_{is}=0 by I_{IN} =0 (e.g. during deenergizing of inductive loads):					
Sense current saturation	$I_{IS,lim}$	6.5	--	--	mA
Current sense leakage current $I_{IN} = 0, \ V_{IS} = 0$:	$I_{IS(LL)}$	--	--	0.5	µA
$V_{IN} = 0, \ V_{IS} = 0, \ I_L \leq 0$:	$I_{IS(LH)}$	--	2	--	
Current sense settling time [20]	$t_{s(IS)}$	--	--	500	µs
Overvoltage protection $T_j = -40°C$: $I_{bb} = 15 \text{mA}$ $T_j = 25...+150°C$:	$V_{bIS(Z)}$	60 / 62	-- / 66	-- / --	V

Input

Parameter and Conditions	Symbol	min	typ	max	Unit
Input and operating current (see diagram page 13) IN grounded (V_{IN} = 0)	$I_{IN(on)}$	--	0.8	1.5	mA
Input current for turn-off [21]	$I_{IN(off)}$	--	--	40	µA

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[19] If V_{ON} is higher, the sense current is no longer proportional to the load current due to sense current saturation, see $I_{IS,lim}$.

[20] not subject to production test, specified by design

[21] We recommend the resistance between IN and GND to be less than 0.5 kΩ for turn-on and more than 500kΩ for turn-off. Consider that when the device is switched off (I_{IN} =0) the voltage between IN and GND reaches almost V_{bb}.

Truth Table

	Input current level	Output level	Current Sense I_{IS}	Remark
Normal operation	L	L	0	
	H	H	nominal	$=I_L / k_{ilis}$, **up to** $I_{IS}=I_{IS,lim}$
Very high load current	H	H	$I_{IS, lim}$	**up to** $V_{ON}=V_{ON(Fold\ back)}$ I_{IS} **no longer proportional to** I_L
Current-limitation	H	H	0	$V_{ON} > V_{ON(Fold\ back)}$ **if** $V_{ON}>V_{ON(SC)}$**, shutdown will occure**
Short circuit to GND	L	L	0	
	H	L	0	
Over-temperature	L	L	0	
	H	L	0	
Short circuit to V_{bb}	L	H	0	
	H	H	<nominal [22]	
Open load	L	Z[23]	0	
	H	H	0	
Negative output voltage clamp	L	L	0	
Inverse load current	L	H	0	
	H	H	0	

L = "Low" Level

H = "High" Level

Overtemperature reset via input: I_{IN}=low and $T_j < T_{jt}$ (see diagram on page 15)

Short circuit to GND: Shutdown remains latched until next reset via input (see diagram on page 14)

Terms
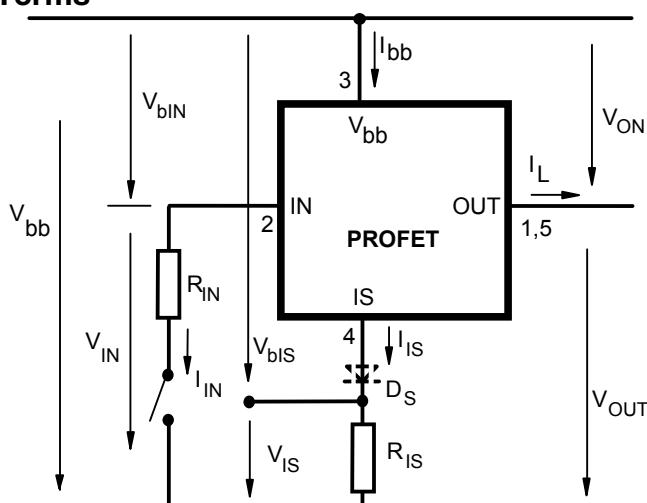
Two or more devices can easily be connected in parallel to increase load current capability.

R_{ON} measurement layout (straight leads)

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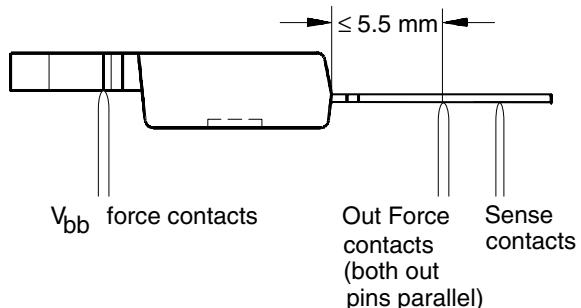
[22] Low ohmic short to V_{bb} may reduce the output current I_L and can thus be detected via the sense current I_{IS}.

[23] Power Transistor "OFF", potential defined by external impedance.

Input circuit (ESD protection)
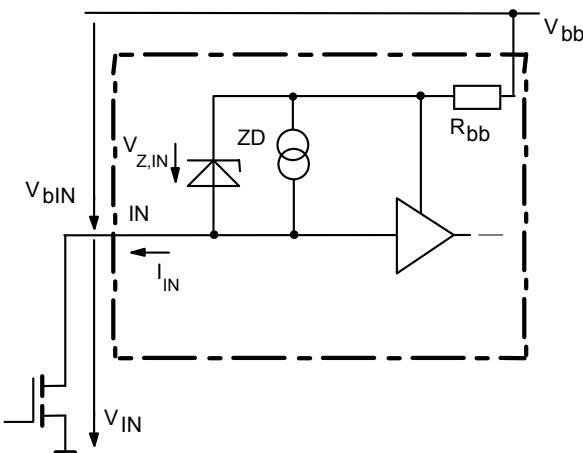
When the device is switched off ($I_{IN} = 0$) the voltage between IN and GND reaches almost V_{bb}. Use a mechanical switch, a bipolar or MOS transistor with appropriate breakdown voltage as driver.
$V_{Z,IN} = 66\,V$ (typ).

Current sense status output
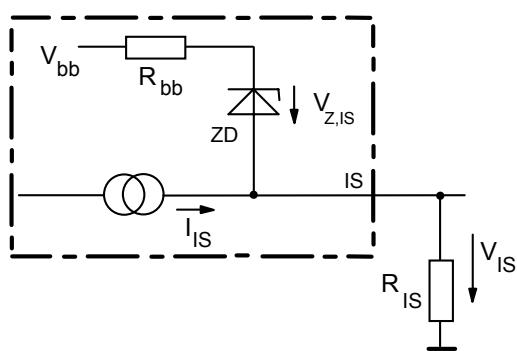
$V_{Z,IS} = 66\,V$ (typ.), $R_{IS} = 1\,k\Omega$ nominal (or $1\,k\Omega$ /n, if n devices are connected in parallel). $I_S = I_L/k_{ilis}$ can be only driven by the internal circuit as long as $V_{out} - V_{IS} > 5V$. If you want to measure load currents up to $I_{L(M)}$, R_{IS} should be less than $\dfrac{V_{bb} - 5V}{I_{L(M)} / K_{ilis}}$.

Note: For large values of R_{IS} the voltage V_{IS} can reach almost V_{bb}. See also overvoltage protection.
If you don't use the current sense output in your application, you can leave it open.

Short circuit detection
Fault Condition: $V_{ON} > V_{ON(SC)}$ (6 V typ.) and $t > t_{d(SC)}$ (80 ...300 µs).
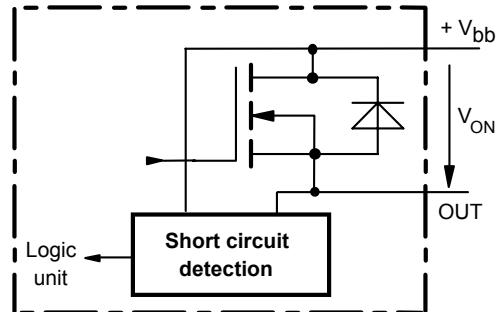
Inductive and overvoltage output clamp
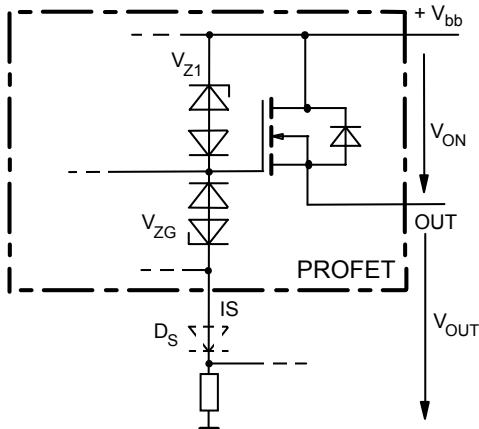
V_{ON} is clamped to $V_{ON(Cl)} = 42\,V$ typ. At inductive load switch-off without D_S, V_{OUT} is clamped to $V_{OUT(CL)} = -17\,V$ typ. via V_{ZG}. With D_S, V_{OUT} is clamped to V_{bb} - $V_{ON(CL)}$ via V_{Z1}. Using D_S gives faster deenergizing of the inductive load, but higher peak power dissipation in the PROFET. In case of a floating ground with a potential higher than 19V referring to the OUT – potential the device will switch on, if diode DS is not used.

Overvoltage protection of logic part
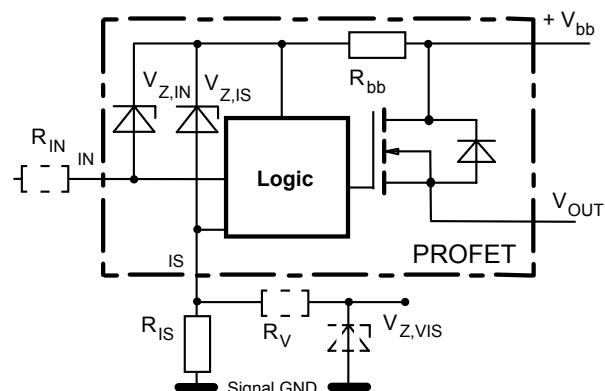
$R_{bb} = 120\,\Omega$ typ., $V_{Z,IN} = V_{Z,IS} = 66\,V$ typ., $R_{IS} = 1\,k\Omega$ nominal. Note that when overvoltage exceeds 71 V typ. a voltage above 5V can occur between IS and GND, if R_V, $V_{Z,VIS}$ are not used.

Reverse battery protection
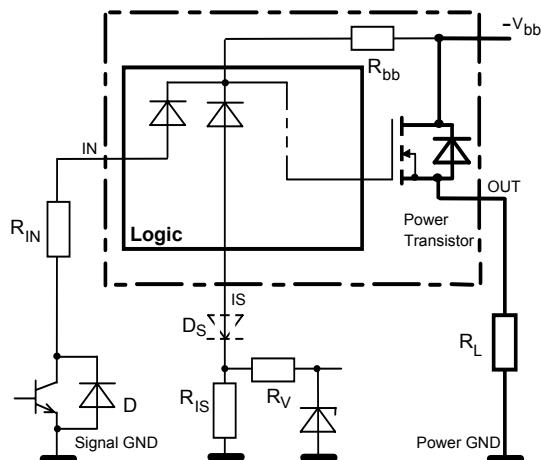
$R_V \geq 1\,\text{k}\Omega$, $R_{IS} = 1\,\text{k}\Omega$ nominal. Add R_{IN} for reverse battery protection in applications with V_{bb} above 16 V[18]; recommended value: $\dfrac{1}{R_{IN}} + \dfrac{1}{R_{IS}} + \dfrac{1}{R_V} = \dfrac{0.1A}{|V_{bb}| - 12V}$ if D_S is not used (or $\dfrac{1}{R_{IN}} = \dfrac{0.1A}{|V_{bb}| - 12V}$ if D_S is used).

To minimize power dissipation at reverse battery operation, the summarized current into the IN and IS pin should be about 120mA. The current can be provided by using a small signal diode D in parallel to the input switch, by using a MOSFET input switch or by proper adjusting the current through R_{IS} and R_V.

V_{bb} disconnect with energized inductive load

Provide a current path with load current capability by using a diode, a Z-diode, or a varistor. ($V_{ZL} < 72$ V or $V_{Zb} < 30$ V if $R_{IN}=0$). For higher clamp voltages currents at IN and IS have to be limited to 250 mA.

Version a:
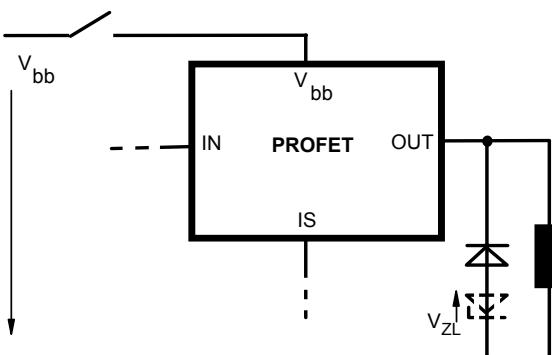
Version b:
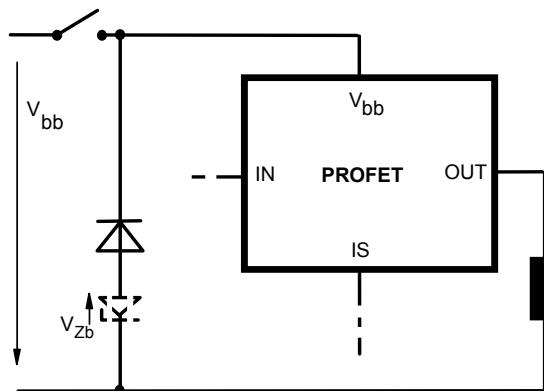
Note that there is no reverse battery protection when using a diode without additional Z-diode V_{ZL}, V_{Zb}.

Version c: Sometimes a neccessary voltage clamp is given by non inductive loads R_L connected to the same switch and eliminates the need of clamping circuit:
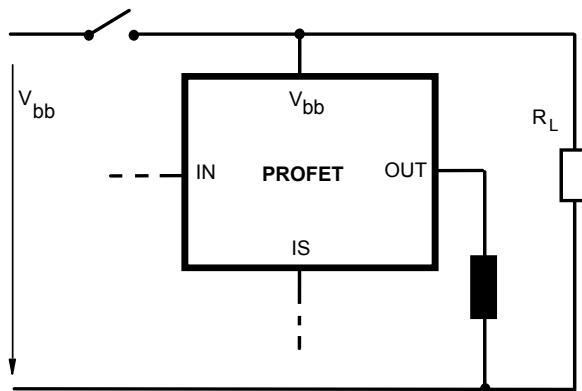
Inverse load current operation
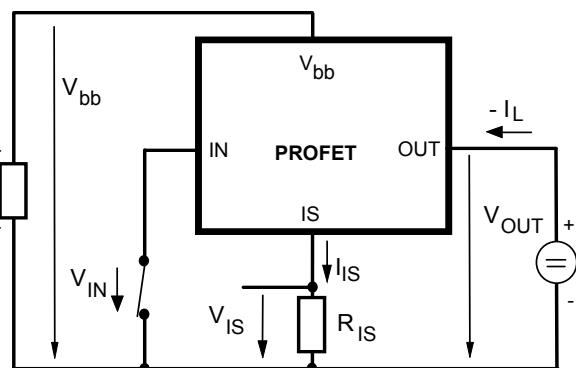
The device is specified for inverse load current operation ($V_{OUT} > V_{bb}$ **> 0V**). The current sense feature is not available during this kind of operation ($I_{IS} = 0$). With $I_{IN} = 0$ (e.g. input open) only the intrinsic drain source diode is conducting resulting in considerably increased power dissipation. If the device is switched on ($V_{IN} = 0$), this power dissipation is decreased to the much lower value $R_{ON(INV)} * I^2$ (specifications see page 4).

Note: *Temperature protection during inverse load current operation is not possible!*

Inductive load switch-off energy dissipation

Energy stored in load inductance:

$$E_L = {}^1/_2 \cdot L \cdot I_L^2$$

While demagnetizing load inductance, the energy dissipated in PROFET is

$$E_{AS} = E_{bb} + E_L - E_R = \int V_{ON(CL)} \cdot i_L(t)\, dt,$$

with an approximate solution for $R_L > 0\,\Omega$:

$$E_{AS} = \frac{I_L \cdot L}{2 \cdot R_L} \left(V_{bb} + |V_{OUT(CL)}| \right)\; ln\left(1 + \frac{I_L \cdot R_L}{|V_{OUT(CL)}|}\right)$$

## Maximum allowable load inductance for a single switch off

$L = f(I_L)$; $T_{j,start} = 150°C$, $V_{bb} = 12\,V$, $R_L = 0\,\Omega$

L [µH]

I_L [A]

Externally adjustable current limit

If the device is conducting, the sense current can be used to reduce the short circuit current and allow higher lead inductance (see diagram above). The device will be turned off, if the threshold voltage of T2 is reached by $I_s * R_{IS}$. After a delay time defined by $R_V * C_V$ T1 will be reset. The device is turned on again, the short circuit current is defined by $I_{L(SC)}$ and the device is shut down after $t_{d(SC)}$ with latch function.
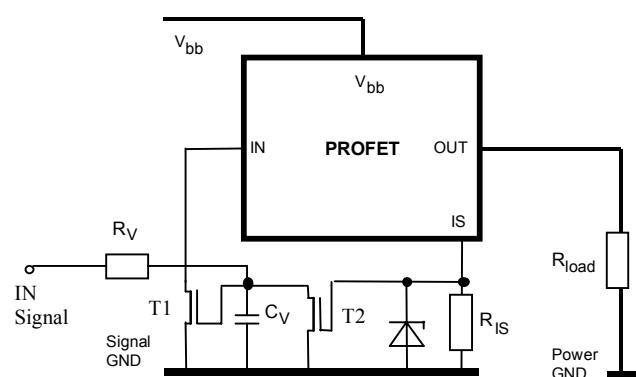
Options Overview

Type BTS	555
Overtemperature protection with hysteresis	X
T_j >150 °C, latch function[24]	X
T_j >150 °C, with auto-restart on cooling	
Short circuit to GND protection	
with overtemperature shutdown	
switches off when V_{ON}>6 V typ. (when first turned on after approx. 180 μs)	X
Overvoltage shutdown	-
Output negative voltage transient limit	
to V_{bb} - $V_{ON(CL)}$	X
to V_{OUT} = -15 V typ	X[25]

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[24] Latch except when V_{bb} - V_{OUT} < $V_{ON(SC)}$ after shutdown. In most cases V_{OUT} = 0 V after shutdown ($V_{OUT} \neq$ 0 V only if forced externally). So the device remains latched unless V_{bb} < $V_{ON(SC)}$ (see page 5). No latch between turn on and $t_{d(SC)}$.

[25] Can be "switched off" by using a diode D_S (see page 8) or leaving open the current sense output.

Characteristics

**Current sense versus load current:**

$I_{IS} = f(I_L)$

I_{IS} [mA]

I_L [A]
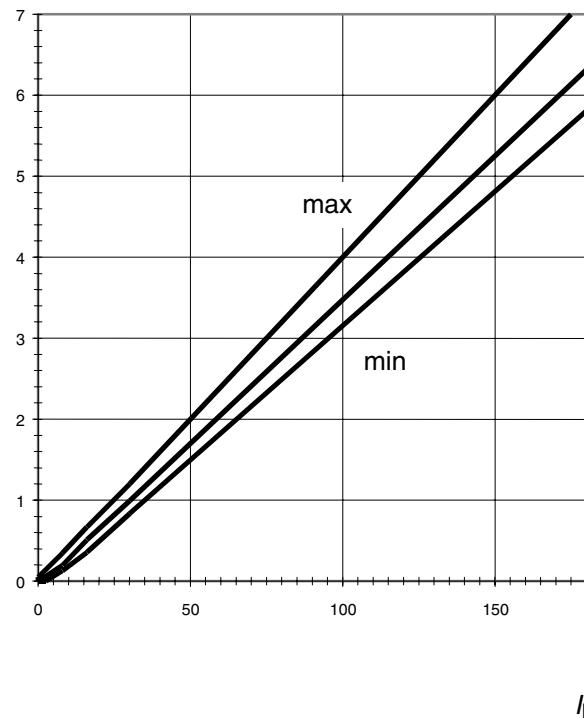
Current sense ratio:

$K_{ILIS} = f(I_L)$, $T_J = 25\ °C$

k_{ilis}

I_L [A]
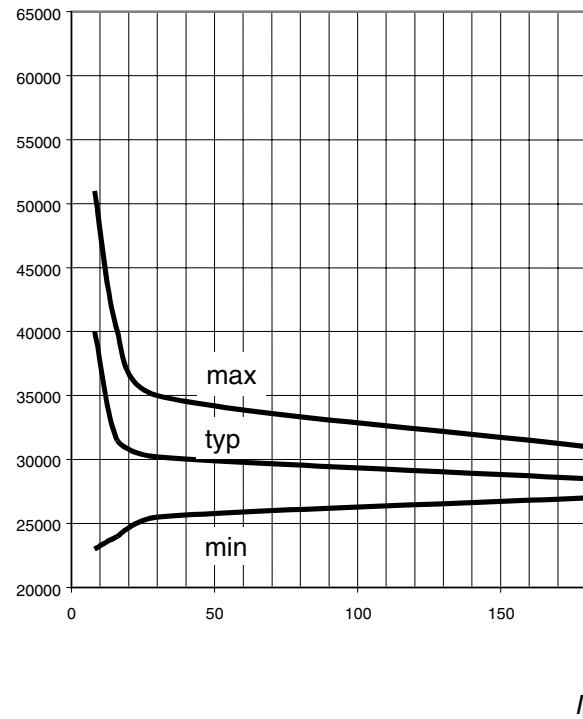
Current sense ratio:

$K_{ILIS} = f(I_L)$, $T_J = -40\ °C$

k_{ilis}

I_L [A]
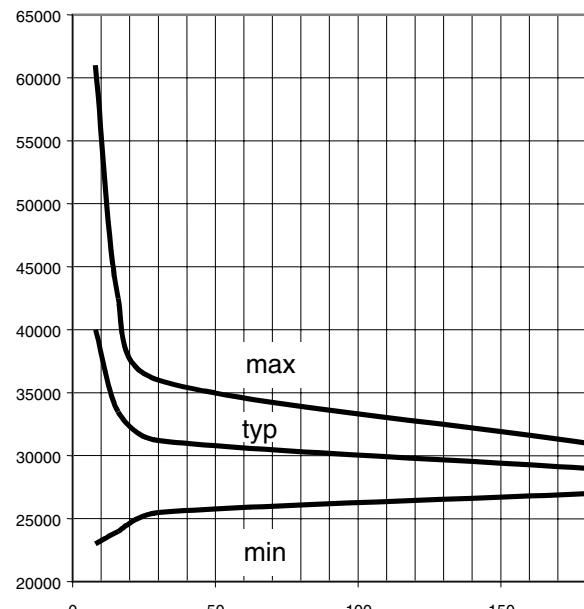
**Current sense ratio:**

$K_{ILIS} = f(I_L)$, $T_J = 150\ °C$

k_{ilis}



I_L [A]
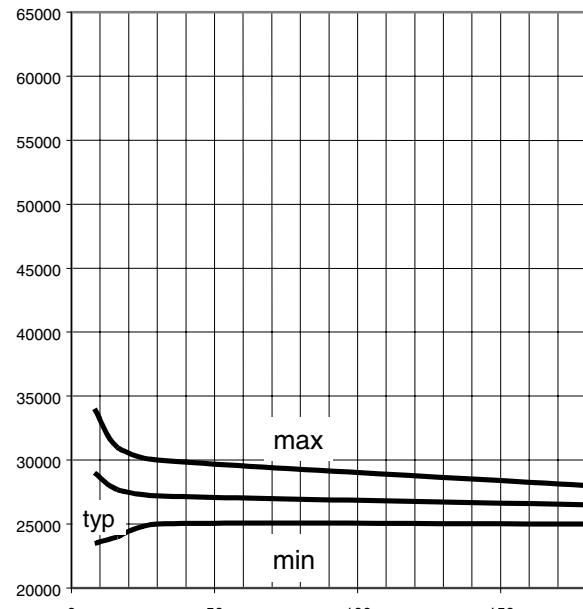
Typ. current limitation characteristic

$I_L = f(V_{ON}, T_j)$
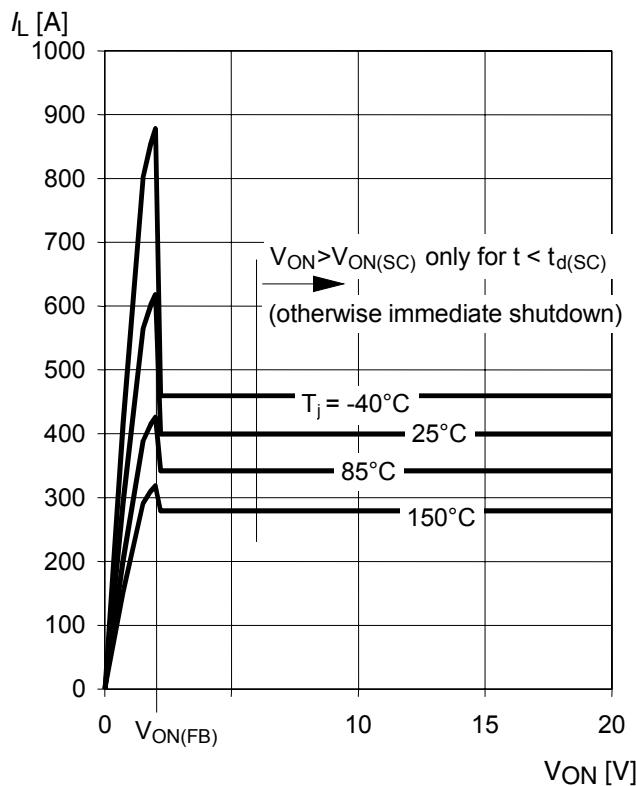
In case of $V_{ON} > V_{ON(SC)}$ (typ. 6 V) the device will be switched off by internal short circuit detection.

Typ. on-state resistance

$R_{ON} = f(V_{bb}, T_j)$; $I_L = 30$ A; $V_{IN} = 0$
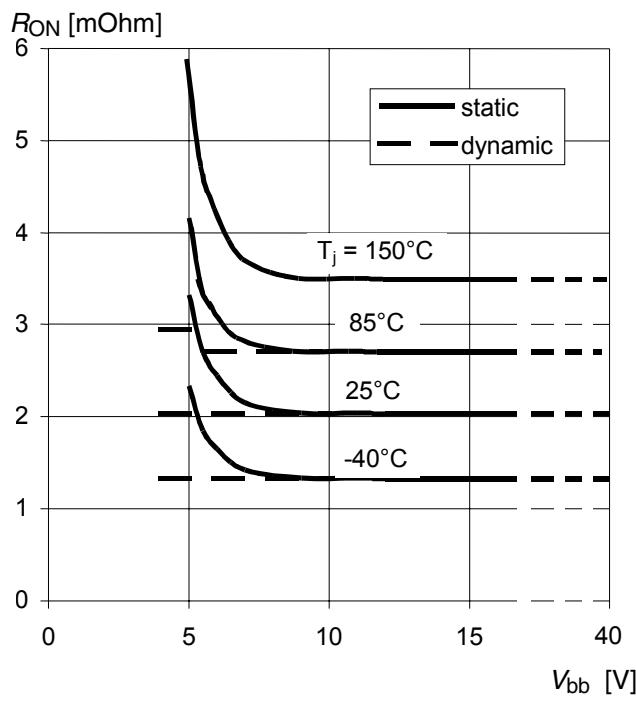

Typ. input current

$I_{IN} = f(V_{bIN})$, $V_{bIN} = V_{bb} - V_{IN}$
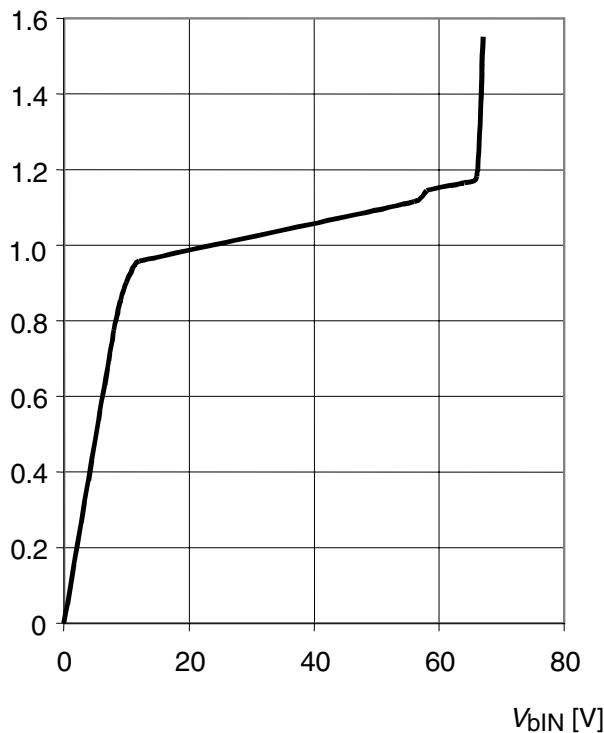
Timing diagrams

Figure 1: Switching a resistive load,
change of load current in on-condition:
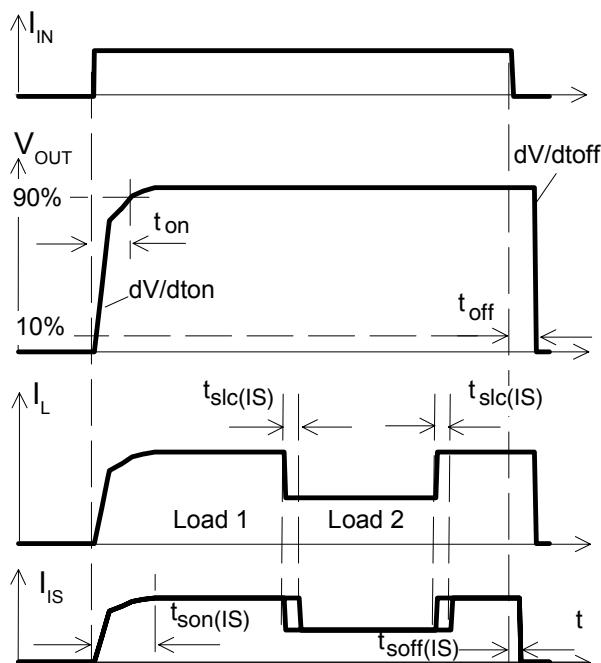
The sense signal is not valid during a settling time
after turn-on/off and after change of load current.

Figure 2a: Switching motors and lamps:
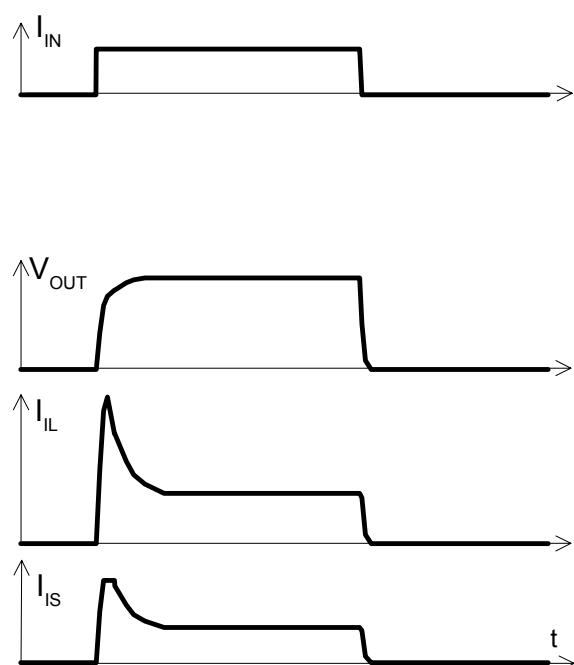
Sense current saturation can occur at very high
inrush currents (see $I_{IS,lim}$ on page 6).

**Figure 2b:** Switching an inductive load:
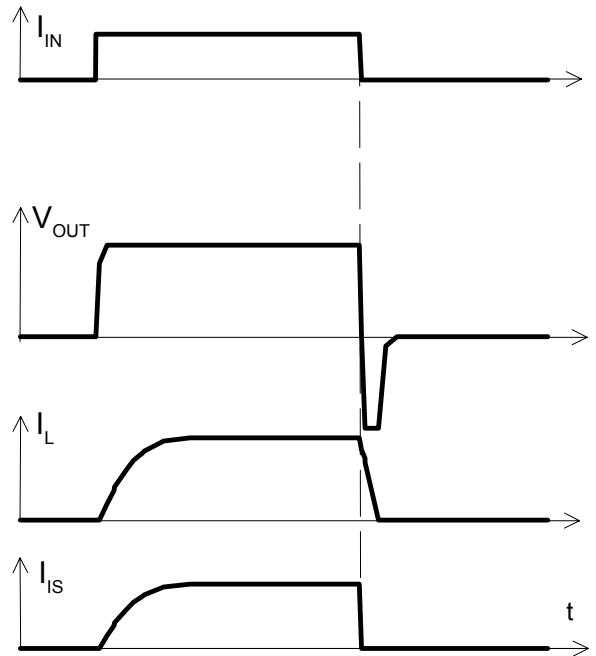
Figure 3: Short circuit:
shut down by short circuit detection, reset by $I_{IN} = 0$.
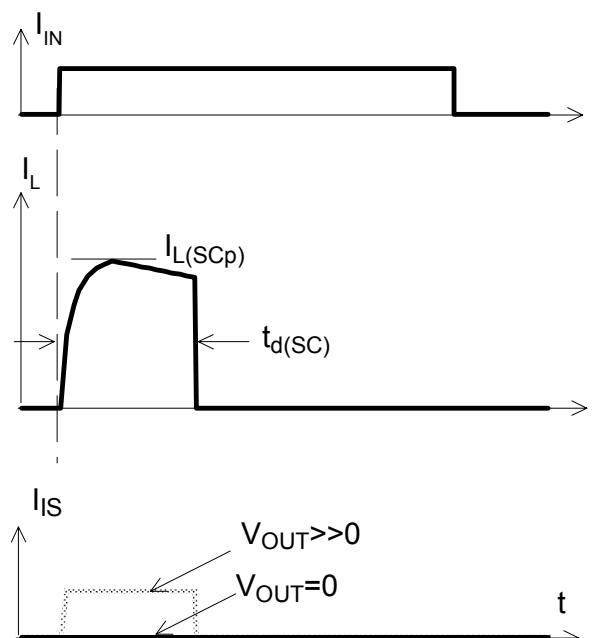
Shut down remains latched until next reset via input.

Figure 4: Overtemperature,
Reset if (I_{IN}=low) and (T_j<T_{jt})
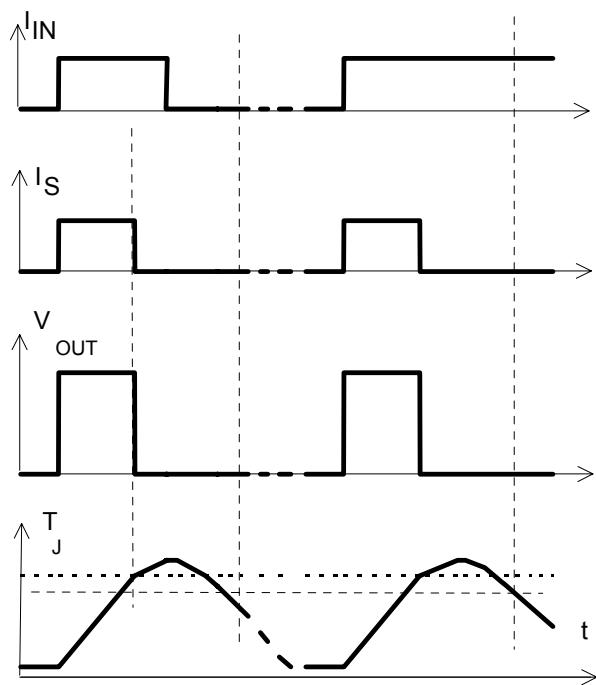
**Figure 5:** Undervoltage restart of charge pump,
overvoltage clamp
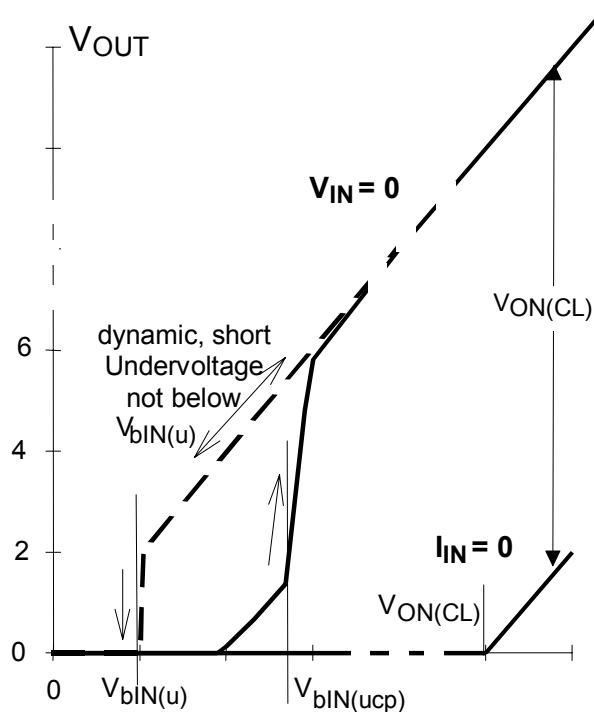
Package Dimensions

All dimensions in mm

PG-TO218-5-146

BTS555 E3146

15 ±0.2
14.8
10.8 ±0.2
4 +0.15
4
20.3 ±0.2
1.7
14 ±0.5
1.1
2.54
0...0.1
0.5 +0.2
$\oplus$ 0.25 Ⓜ A B C
4 x 2.54 = 10.16
A
C
4.9
2 +0.1 -0.02
B
□ 0.06
12.5 ±0.3
1)
0.5 +0.15
2.5

1) Punch direction, burr max. 0.04

General tolerances ± 0.1

P-TO218-5-146-PO V01
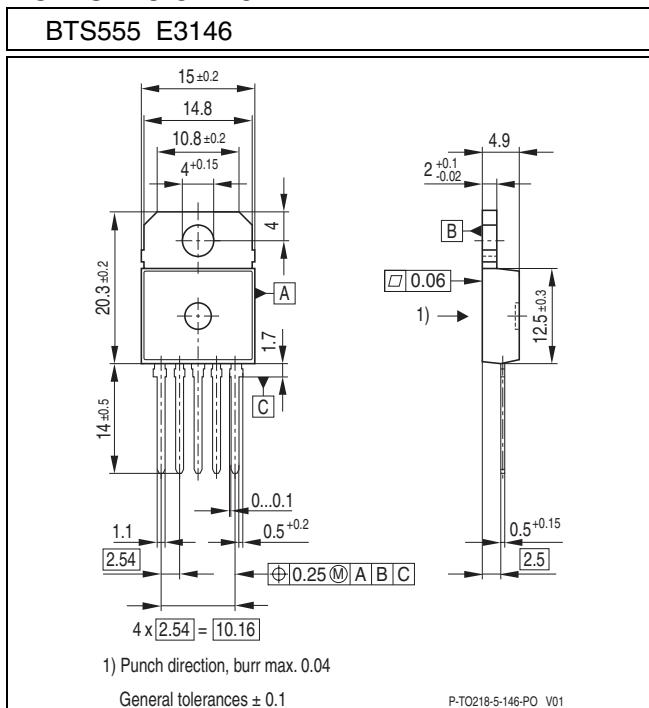
Green Product

To meet the world-wide customer requirements for environmentally friendly products and to be compliant with government regulations the device is available as a green product. Green products are RoHS-Compliant (i.e Pb-free finish on leads).

Revision History

Version	Changes
2010-June-01	RoHS-compliant version of BTS555 Page 1, page 16: RoHS compliance statement and Green product feature added, package variant with staggered leads removed Page 2: pin marking removed. Page 11: Options overview reduced.
2008-June-24	Package drawings updated Revision history added Legal disclaimer updated

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